

GIGABYTE Position in ARM Server Market - Leading Pioneer

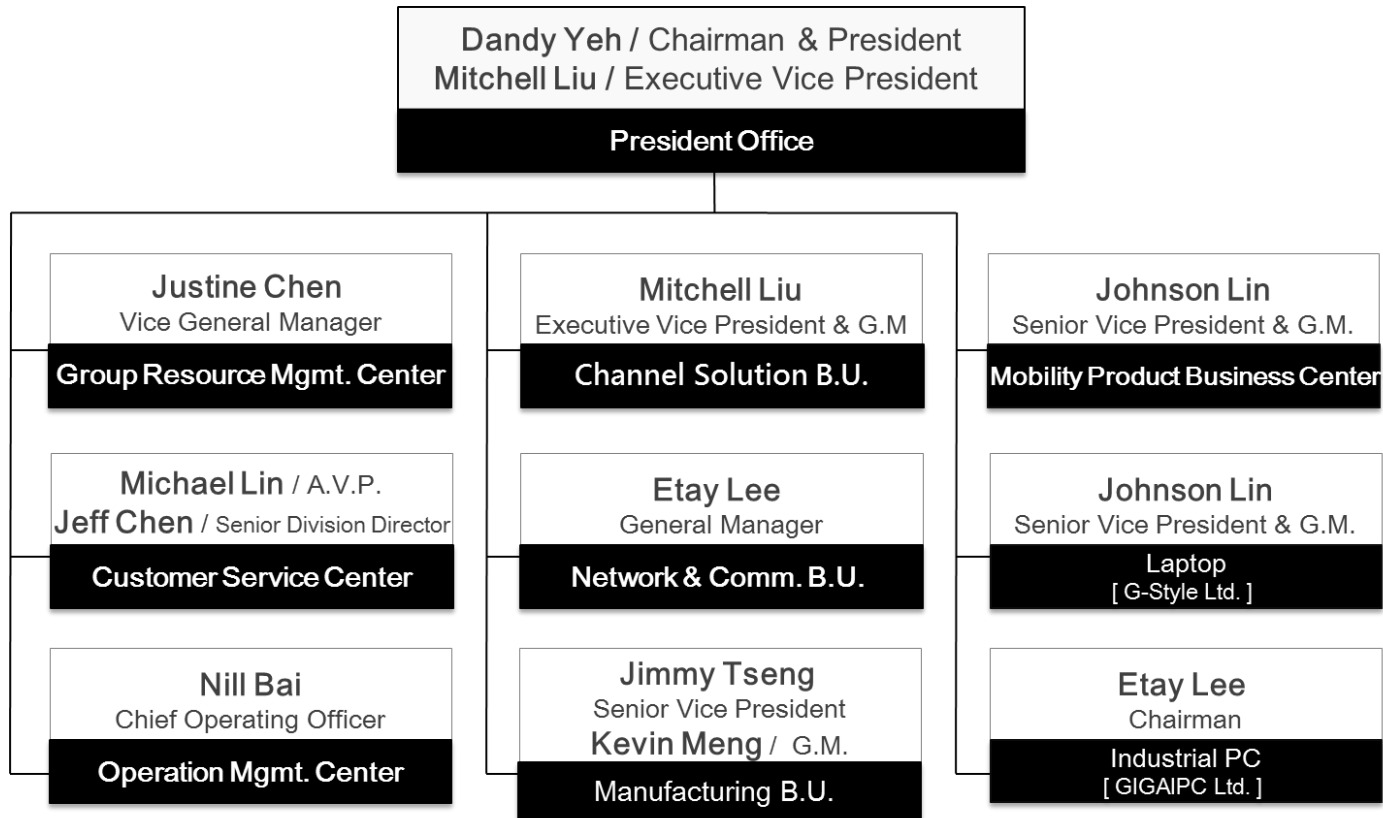
Akira Hoshino
Head of Product Strategy and Planning at GIGABYTE
2018/10/17

Executive Summary

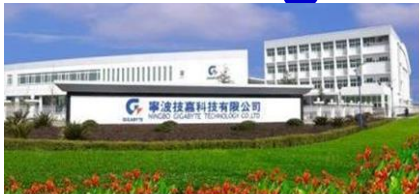


Founded	April 1986
IPO	Listed on TSE since Sept. 24,1998 (Taiwan)
Capital	US\$ 197.61 million (NT\$ 6.29 billion)
Gross Revenue	US\$ 1,624.54 million (NT\$ 52.3 billion @ 32.22)
Certifications	ISO 14064-1:2006, PAS 2050:2008, ISO/TS 16949:2002, IECQ QC 080000 RoHS, ISO9001:2015,OHSAS 18001:2007, ISO 14001:2015
Mfg. Capacity	Motherboard 1,730 K/M, Graphics Card 520 K/M, System Products 200 K/M, Laptop 55 K/M, Server Solution 100 K/M, Embedded and IoT 40 K/M
Purchasing	Direct account of Intel 、AMD 、Nvidia & major ASIC
Technology	Key vendor's alpha & beta site: Intel 、AMD 、Microsoft....
RD Expenditure	3% of revenue per year (= 25% of net profit)
Patents	Filed : 3,529 ; Approved : 2,178

Executive Team



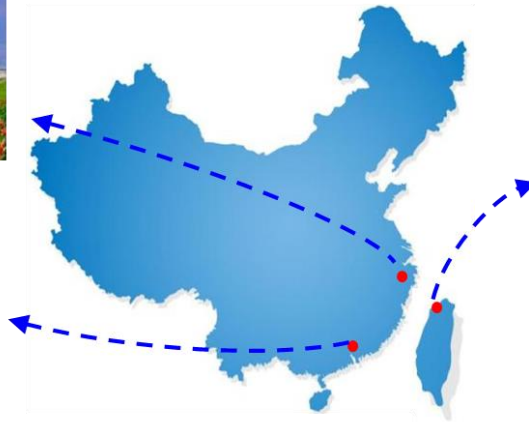
Manufacturing Capacity



Ning-Bo, China



Dong-Guan, China



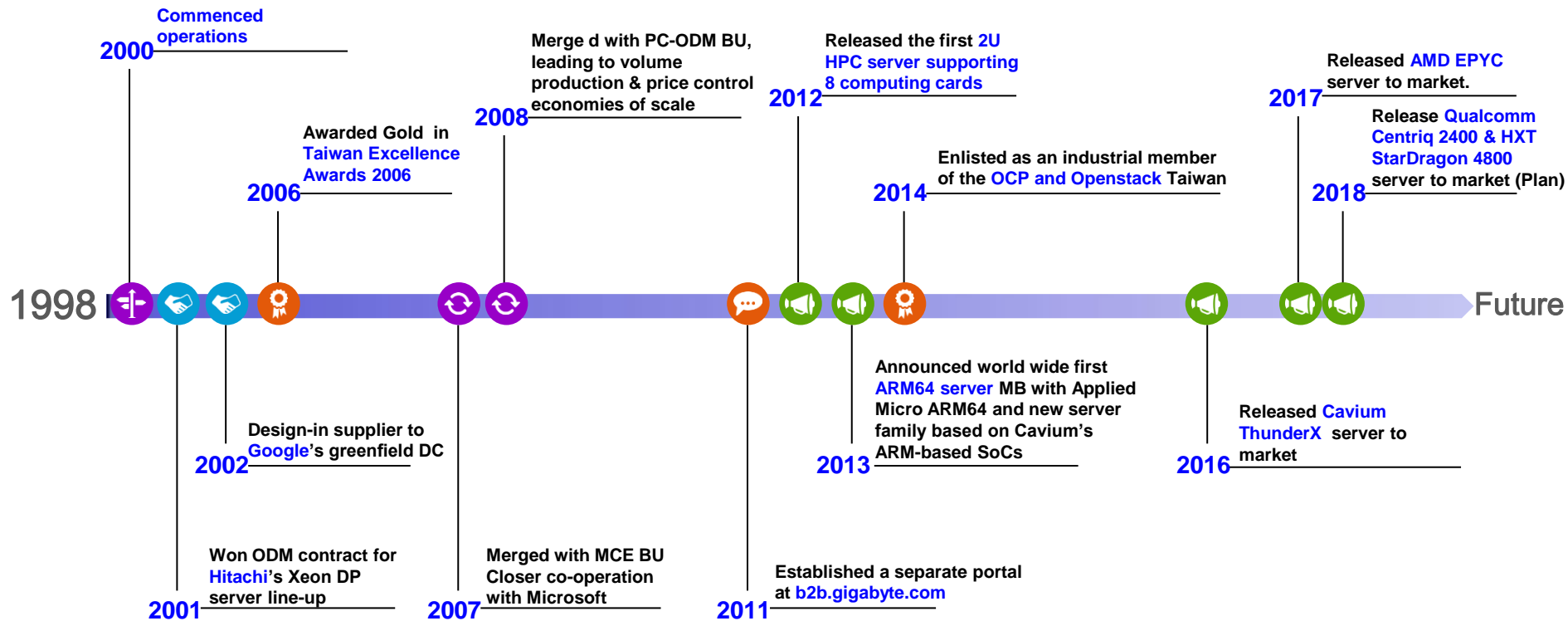
Nan-Ping, Taiwan

Product Type	Ning-Bo	Dong-Guan	Nan-Ping	Total / Monthly
Motherboards	650 K	680 K	400 K	1,730 K
Graphics Cards	100 K	320 K	100 K	520 K
Desktops PC & Peripherals	100 K	95 K	5K	200 K
Laptops	45 K	-	10 K	55 K
Server	30 K	20 K	50 K	100 K
Embedded and IoT	-	-	40 K	40 K
Floor Space	60,000 M ²	38,000 M ²	45,000 M ²	

Global Operation & Support Centers



NCBU Milestone



Milestone of GIGABYTE ARM64 Server

GIGABYTE Product Portfolio



R-Series

Affordable and expandable server rackmounts, offering ease-of-use, low power consumption and quiet operation



H-Series

Compact and scalable systems providing higher density computing power in a smaller footprint for cloud, and large scale-out computing applications



G-Series

Versatile and scalable high performance computing with leading efficiency and performance. Ideal for datacenters



S-Series

Design-optimized storage server providing higher data density for cold storage



W-Series

Tower server providing wide range of Entry, High end computing and HPC



N-Series

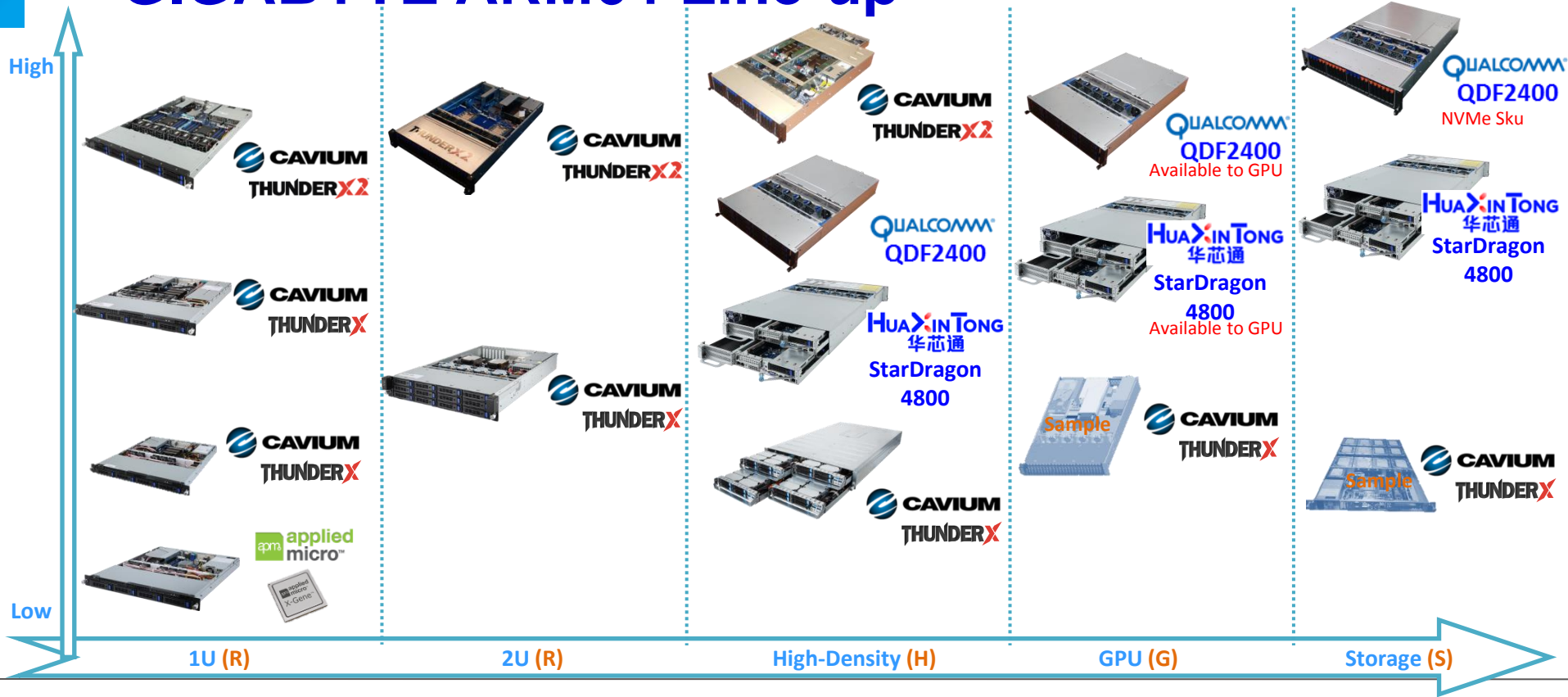
New application of networking server, gateway device and edge computing



RACKLUTION

A datacenter solution simple in design, but also highly efficient in power consumption, computing power and configuration

GIGABYTE ARM64 Line-up



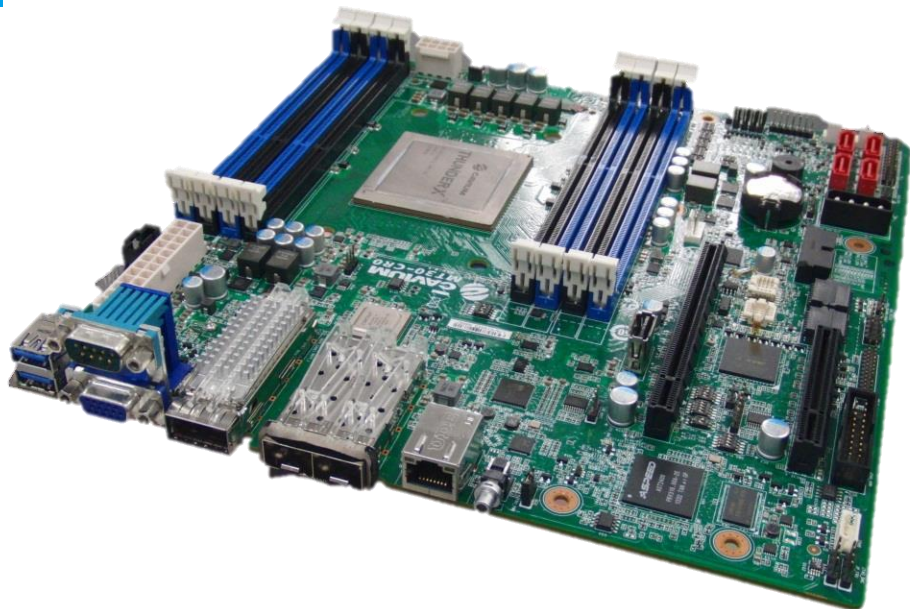
APM X-Gen Worldwide First ARM64 Server



**X-Gen WW First Real Server
2013-2014**



Cavium ThunderX & ThunderX2 CRB



Cavium ThunderX CRB (Reference Board)

2014-2015

THUNDERX



Cavium ThunderX 2 CRB (Reference Board)

2016-2017

THUNDERX2

19th July 2016 ThunderX World Premiere in Shanghai

THUNDERX服务器 全球首发新闻发布会

活动

时间	主题	讲师	时间
1:30pm - 2:00pm	签到		3:00pm - 3:15pm
2:00pm - 2:05pm	欢迎致词	技嘉科技总经理 李宜豪	
2:06pm - 2:11pm	来宾致词	ARM中国区销售副总裁 刘润刚	3:20pm - 3:35pm
2:12pm - 2:17pm	来宾致词	Cavium大中华区销售总监 卢涛	3:40pm - 3:55pm
2:18pm - 2:23pm	来宾致词	Cavium台湾分公司总经理 Sunil Shanker	4:00pm - 4:15pm
2:24pm - 2:29pm	来宾致词	Red Hat首席系统架构师 Jon Masters	4:20pm - 4:35pm
2:30pm - 2:35pm	来宾致词	Linaro 资深技术总监 唐新华	4:40pm - 4:55pm
2:36pm - 2:40pm		活动开始与团体合照	5:00pm - 5:15pm
2:40pm - 3:00pm		茶叙与产品展示	

主办单位: GIGABYTE ARM ascond AvAGO
合作伙伴: Linaro openstack PENGUIN COMPUTING Phoenix

THUNDERX

GIGABYTE ARM ascond AVAGO AVANTEK CAVIUM E4 innodisk
Linaro openstack PENGUIN COMPUTING Phoenix QLOGIC redhat
ubuntu GIGABYTE ARM ascond AVAGO AVANTEK CAVIUM E4
innodisk Linaro openstack PENGUIN COMPUTING Phoenix PROPHECIE QLOGIC redhat
ubuntu GIGABYTE ARM ascond AVAGO AVANTEK CAVIUM
E4 innodisk Linaro openstack PENGUIN COMPUTING Phoenix PROPHECIE QLOGIC

GIGABYTE THUNDERX服务器 全球首发新闻发布会

抢先一步体验
完整认证的ARM服务器解决方案

专供下一代数据中心和云应用使用
受过完整认证和工作负载优化的服务器产品。

英特尔 三星 东芝 西部数据 希捷 铠侠 闪迪 美光 铠侠 闪迪 美光

19th July 2016 ThunderX World Premiere in Shanghai

网易数码 网易首页 应用

网站导航 LOFTER

先人一步！技嘉ThunderX服务器解决方案

2016-07-22 05:48:00 来源: 中关村在线(北京)



微信

微博

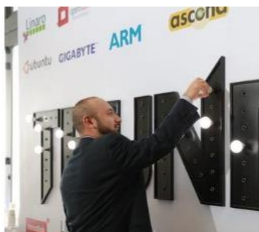
QQ空间

更多

(原标题: 先人一步！技嘉ThunderX服务器解

第1页: ThunderX™服务器解决方案震撼发布

北京时间2016年7月19日,知名主板和服务器厂商技嘉(GIGABYTE)今日与凯为半导体(NASDAQ: CAVM)正式推出市场上第一个ARM双芯片的服务器产品——技嘉ThunderX™服务器解决方案。该方案采用完整的ARM双芯片架构,专为下一代数据中心设计,经过完整认证和测试,可提供卓越的性能和能效。技嘉ThunderX™服务器解决方案是业界首个采用ARM双芯片架构的服务器产品,也是业界首个采用ARM双芯片架构的服务器产品。技嘉ThunderX™服务器解决方案是业界首个采用ARM双芯片架构的服务器产品,也是业界首个采用ARM双芯片架构的服务器产品。



Linaro Partnership and 96 Board

96Boards Developerbox (SynQuacer)

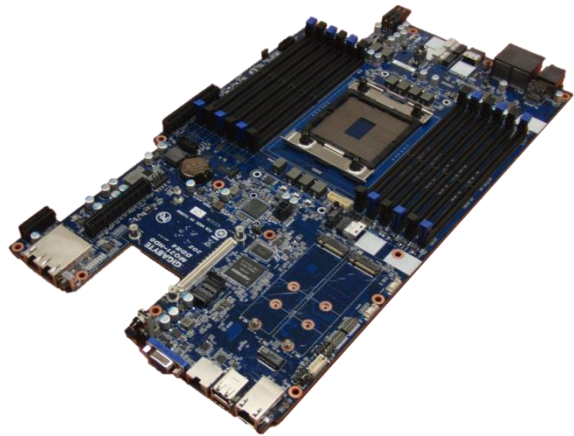
- Latest Tianocore EFI
- RPK Linux Kernel (4.14 / 4.16)
- SynQuacer SC2A11, 24x A53
- Up to 64GB DDR4
- GT-710 GFX

Linaro provided architecture guidance and review to the SoC vendor Socionext, and to the board ODM Gigabyte. This architecture guidance and review included board specifications, board layout, schematics review, in addition to identification of silicon errata fixes. An example of the breadth and depth provided in the following slide.



**Linaro & Socionext 96 Board
2016**

「悟空 Wukong」 Project with Qualcomm



Qualcomm Worldwide First Mainstream
19 Inch Traditional Server (2017-2018)



Key Product of ThunderX2

THUNDERX² SKU Stack

Ordering code	Cores	Frequency (GHz)	PCIe lanes	Memory controllers	GIGABYTE Product Status
CN9980-2200BG4077-Y21-G	32	2.2	56	8	Waiting for Order to Kick off
CN9975-2200BG4077-Y21-G	28	2.2	56	8	Waiting for Order to Kick off
CN9975-2000BG4077-Y21-G	28	2	56	8	Leading Project & Launch
CN9965-2100BG4077-Y21-G	20	2.1	56	6	Under Planning
CN9960-2200BG4077-Y21-G	16	2.2	48	4	Under Planning

THUNDERX² Eco-system

Applications
Tools

Middleware

OS, Firmware

IHV

ODMs/OEMs

Platforms

HPC



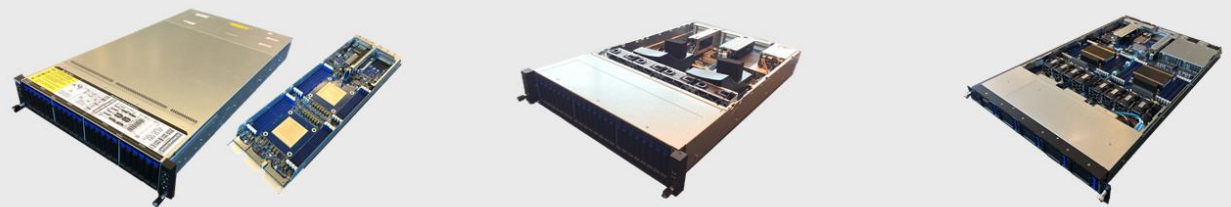
Cloud



Telco/NFV



GIGABYTE™



MT91-FS1 Mother Board



VGA

Dual Dual COM MLAN
10G USB (RJ45)
SFP+ 3.0

ID Button/
LED

ThunderX2 Dual Processor
(CN9975-2000BG4077-Y21-G)

24 x DDR4 Conn.

2 x SATA III 6Gb/s

2 Slimline Conn. Speed: 12Gb/s
For 8 SAS III 12Gb/s w/ LSI 3008

PCI-e x16
(@Gen3 x16 Signals) slot4

Proprietary PCI-e
(@Gen3 x24 Signals) slot3

Proprietary PCI-e
(@Gen3 x24 Signals) slot2
(x16 S/W)

Proprietary PCI-e
(@Gen3 x16 Signals) slot1
Share with slot2

OCP1

OCP2

Qlogic QL41102

AST2500 BMC



Mainstream 1U Dual Socket server R181-T90

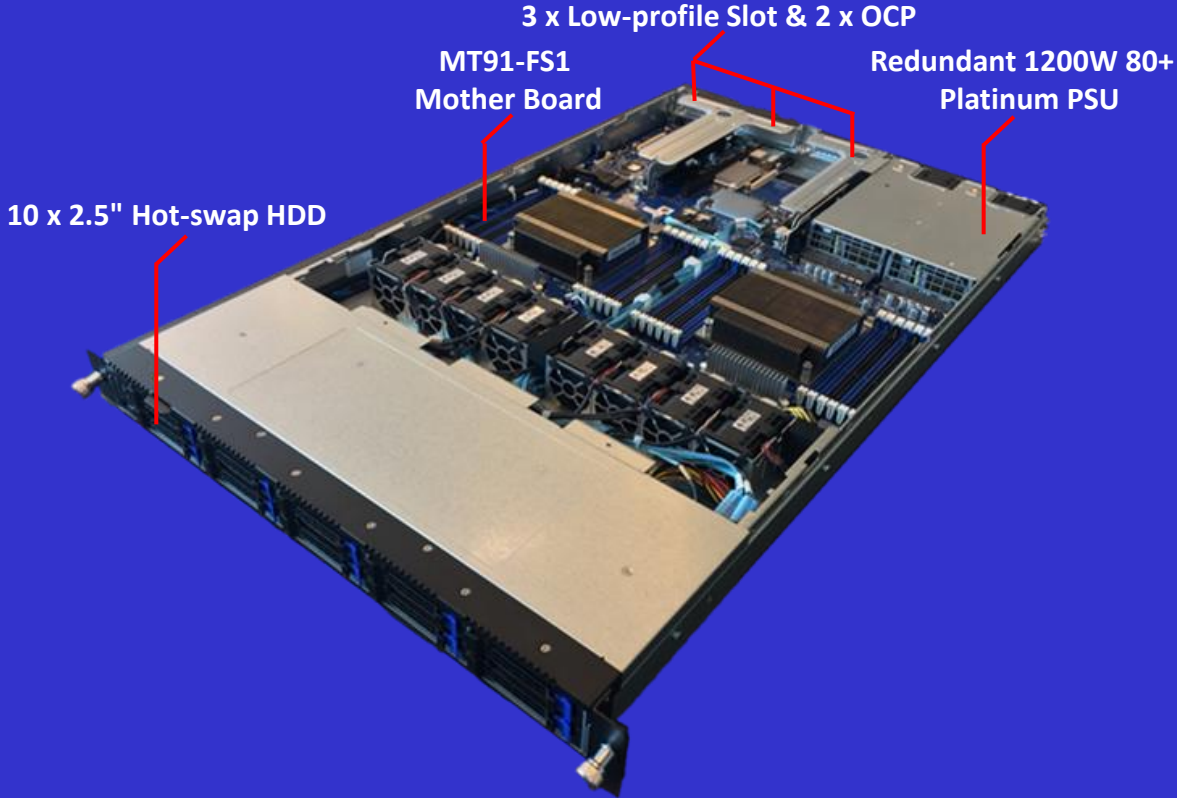


THUNDERX2

**DDR4
2667**

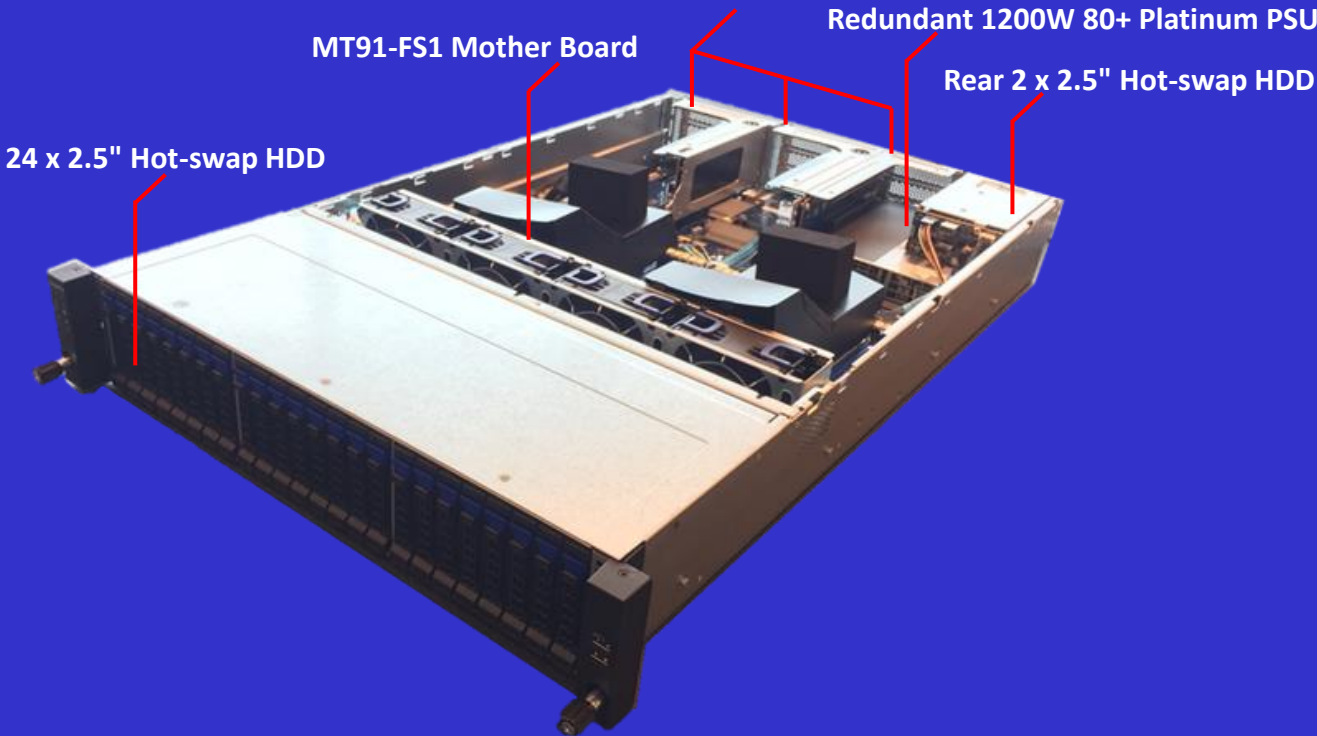
**10 Gigabit
LAN**

**12G
SAS3**

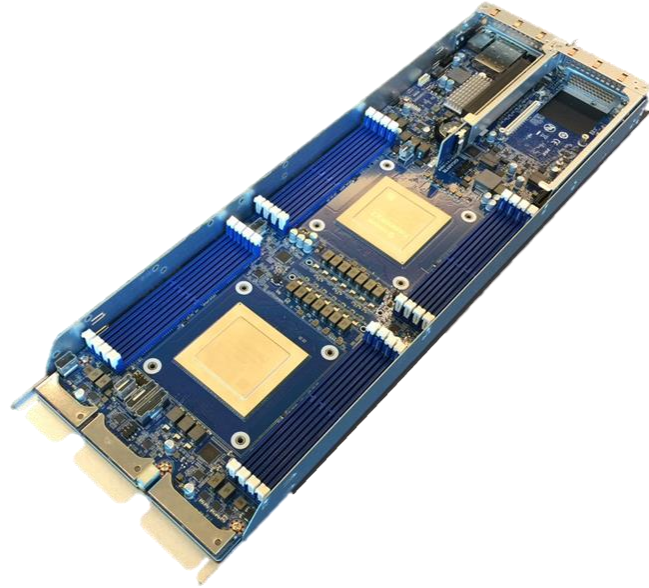


Mainstream 2U Dual Socket server R281-T91

6 x Full Height Half Length & 2 x Low-profile & 2 x OCP



H261 Series Specification - MB (MT61-HD0)



Feature	Specification
Form factor	Proprietary (169 x 525 mm; 6.6" x 20.67")
Processor Support	Cavium ThunderX II CN9975-2000BG4077-Y21-G Dual Processor (BGA)
Memory	16 x DIMM slots, support 8 channel per CPU DDR4 RDIMM 2666/2400/2133 MHz
LAN	2 x SFP+ 10G (Option: QL41202 2 x 25G) 1 x Management LAN 10/100/1G
VGA / VRAM	Integrated in BMC
BMC	ASPEED AST2500
Expansion Slot	1 x PCIe x16 (@Gen 3 x16) from CPU0 1 x PCIe x16 (@Gen 3 x16) from CPU1 1x OCP mezzanine PCIe (@Gen 3 x16) from CPU0 (TYPE 1 P1,P2,P3,P4)
Storage	1 x Slimline for 4 x SATAIII; OS SW RAID 0/1/10/5 support
Rear IO Connector	1 xCOM, 2xSFP+, 1 x MLAN (RJ45), 2 x USB3.0, 1x UID LED
Internal Connector	1x TPM, 1xVGA

H261 Series Specification - System



Feature	Specification
Dimension	2U 4 node Rack (87.5 x 440 x 820 mm; 3.44" x 17.32" x 32.28")
Mother Board Spec	Half width MB = MT61-HD0
Drive Bay	(T60)12 x 3.5" Hot-swap HDD (3 x HDD per Node) (T61)16 x 2.5" Hot-swap HDD & 8 x Dummy cover (4 x HDD & 2 x Dummy cover; Default 4 x SATA3 per Node); No ODD
Expansion Slot	2 x Low Profile Slot (Per node) 1 x OCP Mezzanine Card (TYPE 1 P1,P2,P3,P4) (Per node)
Power Supply	Redundant 2200W 80+ Platinum
System Cooling	8 x 8038 Redundant Fan Wall
Front Panel	Power On/Off Button (Including LED); ID Button (Including LED)
Backplane	SAS(12Gb/s) / SATA(6Gb/s) HDD Backplane

Key Product of Centriq 2400 & StarDragon 4800

Qualcomm Centriq 2400 Eco-system

Enabling tech



Cloud / mgmt



Languages, runtimes



Virtualization



Tools

GCC / LLVM / Debuggers (JTAG, GDB) / Libraries (glibc, others)

OS











































Firmware platform mgmt

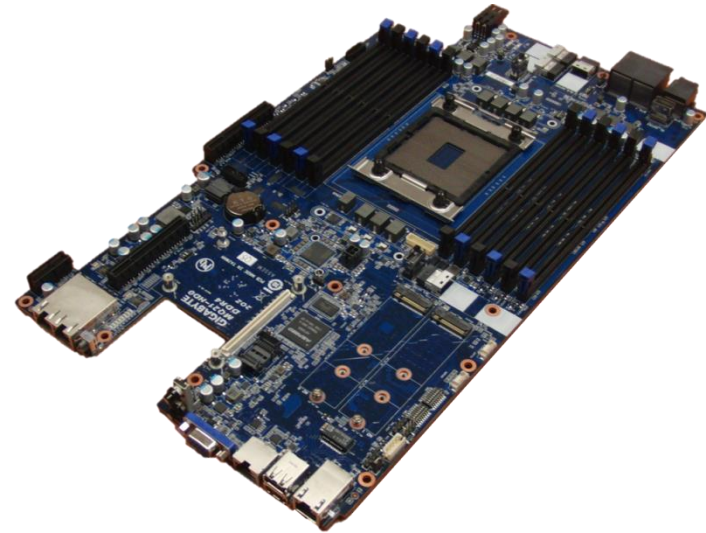
HW Root of Trust / Trusted Execution
Environment / Power Management / Secure Boot



HXT StarDragon 4800 Eco-system

HXT 华芯通半导体		Open Source & Domestic Ecosystem 开源生态系统与国内生态系统	
Solution 解决方案	      		
Database 数据库	   		
Middleware 中间件	         		
Cloud Infra 云架构	     		
Virtualization 虚拟化	   		
OS 操作系统	     		
Firmware 固件	  		

Wukong Project MB (MQ21-HD0) Spec



Feature	Specification
Form factor	Proprietary (383 x 220 mm)
Processor	Qualcomm QDF2400 SoC
Support	HXT StarDragon 4800
Chipset	SoC
Memory	12 x DIMM slots support/6 channel DDR4 2400 to 2667 MT/s @ R-DIMM / LR-DIMM
LAN	2 x 1G Base-T (1 x 1G Base-T for Debug only) 1 x Management LAN 10/100/1G
VGA / VRAM	Integrated in BMC
BMC	ASPEED AST2500
Expansion Slot	1 x PCIe x16 (@Gen 3 x16) or 2 x8 1x OCP mezzanine PCIe (@Gen 3 x8)(TYPE 1 P1,P2,P3,P4 with NCSI support)
Storage	6 x SATA(6Gb/s) 2 x M.2 (@SATA , 2280 size)
Rear IO Connector	1 x VGA, 2 x RJ45, 1 x MLAN, 2 x USB2.0, 1 x ID Button, 1x COM (RJ45), System RST BTN; PWR BTN,
Internal Connector	1x TPM
TPM	I/F w/ Add-on kit (Optional)

Wukong Project Sku1 (H221-Q20) Spec



Feature	Specification
Dimension	2U Rack (87 x 440 x 750 mm ; 3.43" x 17.32" x 29.52")
Mother Board Spec	Half width MB = MQ21-HD0
Drive Bay	2U-2Node:12 x 3.5" Hot-swap Drive Bays Per node 6 x Front LFF SAS or SATA, Hot swap Onboard 2 x M.2 SATA
Expansion Slot	Per node: 1 x Low Profile Slot,1 x FHFL Slot , 1 x OCP Mezzanine Card
Power Supply	Redundant 1200W 80+ Platinum (Default for 2U-2Node 3.5" SKU)
System Cooling	5 x 6038 N+1 Redundant Fan Wall (Option: 10 x 6038 Redundant Fan Wall)
Front Panel	Power On/Off Button (Including LED); ID Button (Including LED)
Backplane	SAS(12Gb/s) / SATA(6Gb/s)

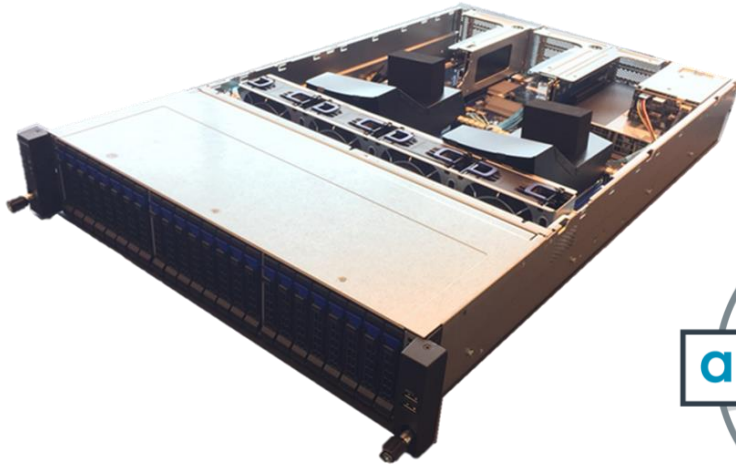
Wukong Project Sku2 (H221-Q21) Spec



Feature	Specification
Dimension	2U Rack (87 x 440 x 720 mm ; 3.43" x 17.32" x 28.34")
Mother Board Spec	Half width MB = MQ21-HD0
Drive Bay	2U-2Node: 24 x 2.5" Hot-swap Drive Bays Per node Front 8 x U.2 SFF hot swap & 4 x LFF SAS or SATA hot swap Onboard 2 x M.2 SATA
Expansion Slot	Per node: 1 x Low Profile Slot (N/A) 1 x FHFL Slot (for PCIe Expander card) 1 x OCP Mezzanine Card (PCIe Gen3 x8)
Power Supply	Redundant 1600W 80+ Platinum
System Cooling	5 x 6038 N+1 Redundant Fan Wall (Option: 10 x 6038 Redundant Fan Wall)
Front Panel	Power On/Off Button (Including LED); ID Button (Including LED)
Backplane	SAS(12Gb/s) / SATA(6Gb/s) /NVMe HDD Backplane

Exciting News

ARM Server Ready & Certification



THUNDERX2™

QUALCOMM®
HUA XIN TONG (Plan)
华芯通

GIGABYTE™

GIGABYTE™

Upgrade Your Life

